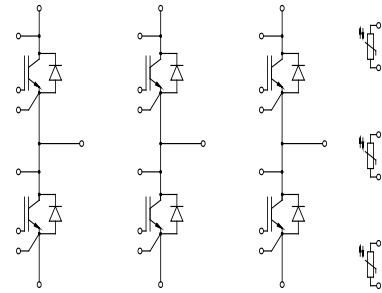
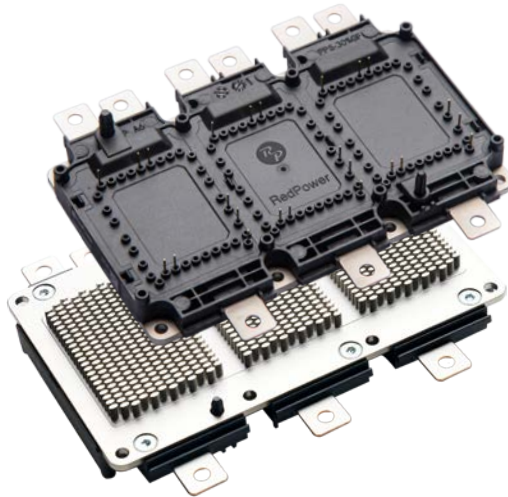


A6 package: 750V 950A IGBT module



等效电路图
Equivalent Circuit Schematic

Features:

- 750V 950A, $V_{CE(sat)} = 1.43V @ 25^{\circ}C$
- Direct cooled PinFin Base Plate
- Micro pattern trench/FS Technology
- Low switching losses

产品特性:

- 750V 950A, $V_{CE(sat)} = 1.43V @ 25^{\circ}C$
- PinFin 直接液冷散热底板
- 微沟槽栅/场终止技术
- 低开关损耗

Typical Applications:

- Electric Vehicles
- Motor Drives

典型应用:

- 电动汽车
- 电机驱动

IGBT, Inverter / IGBT, 逆变部分

Maximum Rated Values / 最大标称参数

Collector-emitter voltage 集电极-发射极电压	$T_{vj}=25^{\circ}\text{C}$	V_{CES}	750	V
Implemented collector current 连续集电极电流		$I_{C\text{ nom}}$	950	A
Continuous DC collector current 集电极连续直流电流	$T_F=95^{\circ}\text{C}, T_{vj\text{ max}}=175^{\circ}\text{C}$	I_C	570 ¹⁾	A
Repetitive peak collector current 集电极可重复峰值电流	$t_p=1\text{ms}$	I_{CRM}	1900 ¹⁾	A
Gate-emitter peak voltage 门极-发射极峰值电压		V_{GES}	± 20	V

Characteristic Values / 性能参数

			min.	typ.	max.		
Collector-emitter saturation voltage 集电极-发射极饱和压降	$I_C=450\text{A}, V_{GE}=15\text{V}$	$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=150^{\circ}\text{C}$ $T_{vj}=175^{\circ}\text{C}$	$V_{CE\text{ sat}}$	1.15	1.45	V	
	$I_C=950\text{A}, V_{GE}=15\text{V}$	$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=175^{\circ}\text{C}$		1.43	1.9		
Gate threshold voltage 门极阈值电压	$V_{CE}=V_{GE}, I_C=9.6\text{mA},$	$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=175^{\circ}\text{C}$	$V_{GE\text{ th}}$	5.0	6.0 3.8	7.0	V
Internal gate resistor 内置门极电阻		$T_{vj}=25^{\circ}\text{C}$	$R_{G\text{ int}}$	0.43			Ω
Input capacitance 输入电容	$V_{CE}=25\text{V}, V_{GE}=0\text{V}, f=100\text{kHz}, T_{vj}=25^{\circ}\text{C}$		C_{ies}	106			nF
Reverse transfer capacitance 反向传输电容	$V_{CE}=25\text{V}, V_{GE}=0\text{V}, f=100\text{kHz}, T_{vj}=25^{\circ}\text{C}$		C_{res}	0.39			nF
Gate charge 门极电荷	$V_{GE}=-8\text{V}\sim+15\text{V}, V_{CE}=400\text{V}$		Q_G	4.38			μC
Collector-emitter cutoff current 集电极-发射极关断漏电流	$V_{CE}=750\text{V}, V_{GE}=0\text{V},$	$T_{vj}=25^{\circ}\text{C}$	I_{CES}			1	mA
Gate-emitter leakage current 门极-发射极漏电流	$V_{CE}=0\text{V}, V_{GE}=20\text{V},$	$T_{vj}=25^{\circ}\text{C}$	I_{GES}			400	nA
Turn-on delay time, inductive load 开通延迟时间, 感性负载	$I_C=450\text{A}, V_{CE}=400\text{V}$ $V_{GE}=-8\text{V}/15\text{V}$ $R_{Gon}=1.0\Omega$	$T_{vj}=25^{\circ}\text{C}$	t_{don}	140			ns
		$T_{vj}=150^{\circ}\text{C}$		160			
		$T_{vj}=175^{\circ}\text{C}$		162			
Rise time, inductive load 上升时间, 感性负载	$I_C=450\text{A}, V_{CE}=400\text{V}$ $V_{GE}=-8\text{V}/15\text{V}$ $R_{Gon}=1.0\Omega$	$T_{vj}=25^{\circ}\text{C}$	t_r	53			ns
		$T_{vj}=150^{\circ}\text{C}$		65			
		$T_{vj}=175^{\circ}\text{C}$		67			
Turn-off delay time, inductive load 关断延迟时间, 感性负载	$I_C=450\text{A}, V_{CE}=400\text{V}$ $V_{GE}=-8\text{V}/15\text{V}$ $R_{Goff}=5.0\Omega$	$T_{vj}=25^{\circ}\text{C}$	t_{doff}	756			ns
		$T_{vj}=150^{\circ}\text{C}$		863			
		$T_{vj}=175^{\circ}\text{C}$		890			
Fall time, inductive load 下降时间, 感性负载	$I_C=450\text{A}, V_{CE}=400\text{V}$ $V_{GE}=-8\text{V}/15\text{V}$ $R_{Goff}=5.0\Omega$	$T_{vj}=25^{\circ}\text{C}$	t_f	77			ns
		$T_{vj}=150^{\circ}\text{C}$		164			
		$T_{vj}=175^{\circ}\text{C}$		177			
Turn-on energy loss per pulse 开通损耗	$I_C=450\text{A}, V_{CE}=400\text{V}, L_s=30\text{nH}$ $V_{GE}=-8\text{V}/15\text{V}, R_{Gon}=1.0\Omega$ $di/dt(T_{vj}=25^{\circ}\text{C})=6750\text{A/us}$ $di/dt(T_{vj}=150^{\circ}\text{C})=5500\text{A/us}$	$T_{vj}=25^{\circ}\text{C}$	E_{on}	9.65			mJ
		$T_{vj}=150^{\circ}\text{C}$		13.8			
		$T_{vj}=175^{\circ}\text{C}$		15.2			
Turn-off energy loss per pulse 关断损耗	$I_C=450\text{A}, V_{CE}=400\text{V}, L_s=30\text{nH}$ $V_{GE}=-8\text{V}/15\text{V}, R_{Goff}=5.0\Omega$ $dv/dt(T_{vj}=25^{\circ}\text{C})=7600\text{V/us}$ $dv/dt(T_{vj}=150^{\circ}\text{C})=4760\text{V/us}$	$T_{vj}=25^{\circ}\text{C}$	E_{off}	22.2			mJ
		$T_{vj}=150^{\circ}\text{C}$		31.5			
		$T_{vj}=175^{\circ}\text{C}$		33.6			

¹⁾非测试值, 设计计算所得

SC data 短路耐量	$V_{GE}=15V/-8V$, $V_{CC}=400V$, $V_{CEmax} \leq 750V$	$t_p \leq 6\mu s, T_{vj}=25^\circ C$ $t_p \leq 3\mu s, T_{vj}=175^\circ C$	I_{sc}		5200 4100		A
Thermal resistance, junction to cooling fluid 结-冷却液热阻	Per IGBT, $\Delta V/\Delta t=10dm^3/min$ $T_F=65^\circ C$		R_{thJF}		0.08		K/W
Temperature under switching conditions 工作温度	t_{op} continuous for 10s within a period of 30s, occurrence maximum 3000 times over lifetime		$T_{vj op}$	-40 150		150 175	$^\circ C$

Diode, Inverter / 二极管, 逆变部分

Maximum Rated Values / 最大标称参数

Repetitive peak reverse voltage 可重复反向峰值电压	$T_{vj}=25^\circ C$	V_{RRM}	750	V
Implemented forward current 连续正向电流		$I_{F nom}$	950	A
Repetitive peak forward current 可重复正向峰值电流	$t_p=1ms$	I_{FRM}	1900 ¹⁾	A

Characteristic Values / 性能参数

			min.	typ.	max.		
Forward voltage 正向通态压降	$I_F=450A, V_R=0V$	$T_{vj}=25^\circ C$	V_F	1.33	1.75	V	
		$T_{vj}=150^\circ C$		1.21			
		$T_{vj}=175^\circ C$		1.16			
	$I_F=950A, V_R=0V$	$T_{vj}=25^\circ C$		1.59	2.1		
		$T_{vj}=175^\circ C$		1.46			
Peak reverse recovery current 反向恢复峰值电流	$I_F=450A, V_R=400V$ $-di_F/dt=4000A/\mu s(T_{vj}=150^\circ C)$ $V_{GE}=-8V$	$T_{vj}=25^\circ C$ $T_{vj}=150^\circ C$ $T_{vj}=175^\circ C$	I_{RM}	343 398 420		A	
Recovery charge 反向恢复电荷	$I_F=450A, V_R=400V$ $-di_F/dt=4000A/\mu s(T_{vj}=150^\circ C)$ $V_{GE}=-8V$	$T_{vj}=25^\circ C$ $T_{vj}=150^\circ C$ $T_{vj}=175^\circ C$	Q_r	27.5 47.5 55.5		μC	
Reverse recovery energy 反向恢复损耗	$I_F=450A, V_R=400V$ $-di_F/dt=4000A/\mu s(T_{vj}=150^\circ C)$ $V_{GE}=-8V$	$T_{vj}=25^\circ C$ $T_{vj}=150^\circ C$ $T_{vj}=175^\circ C$	E_{rec}	7.4 15 17.3		mJ	
Thermal resistance, junction to cooling fluid 结-冷却液热阻	Per FRD, $\Delta V/\Delta t=10dm^3/min$ $T_F=65^\circ C$		R_{thJF}		0.116		K/W
Temperature under switching conditions 工作温度	t_{op} continuous for 10s within a period of 30s, occurrence maximum 3000 times over lifetime		$T_{vj op}$	-40 150		150 175	$^\circ C$

¹⁾ 非测试值, 设计计算所得

NTC-Thermistor/ NTC-热敏电阻
Characteristic Values / 性能参数

		min.	typ.	max.		
Rated resistance 标称电阻	$T_C=25^\circ\text{C}$	R_{25}	5.00			$\text{K}\Omega$
Deviation of R100 R100 偏移值	$T_C=100^\circ\text{C}$, $R_{100}=493.3\Omega$	$\Delta R/R$	-5	5		%
Power dissipation 功率耗散	$T_C=25^\circ\text{C}$	P_{25}		20		mW
B-value B 值	$R_2=R_{25} \exp[B_{25/50}(1/T_2-1/(298.15\text{K}))]$	$B_{25/50}$	3375			K
B-value B 值	$R_2=R_{25} \exp[B_{25/80}(1/T_2-1/(298.15\text{K}))]$	$B_{25/80}$	3414			K
B-value B 值	$R_2=R_{25} \exp[B_{25/100}(1/T_2-1/(298.15\text{K}))]$	$B_{25/100}$	3436			K

Module / 模块

Isolation test voltage 绝缘测试电压	RMS, $f=50\text{Hz}$, $t=1\text{min}$	V_{ISOL}	3.0			KV
Material of module baseplate 模块底板材料			Cu+Ni ¹⁾			
Internal isolation 内部绝缘			Si ₃ N ₄			
Creepage distance 爬电距离	Terminal to heatsink Terminal to terminal	d_{Creep}	9.0 9.0			mm
Clearance 电气间隙	Terminal to heatsink Terminal to terminal	d_{Clear}	4.5 4.5			mm
Comparative tracking index 相对漏电起痕指数		CTI	200 ²⁾			

min. typ. max.

Stray inductance module 模块杂散电感		L_{sCE}	8.5			nH
Module lead resistance, terminals-chip 模块引脚电阻, 端子-芯片	$T_C=25^\circ\text{C}$, Per switch	$R_{\text{CC}'+\text{EE}'}$	0.75			m Ω
Storage temperature 贮存温度		T_{stg}	-40	125		$^\circ\text{C}$
Mounting torque for module mounting 模块安装力矩	Baseplate to heatsink, Screw M4	M	1.8		2.2	Nm
	Terminal connection, Screw M5		3.6		4.4	
	PCB to frame		0.5		0.6	
Weight 重量		G	760			g

1) 铜底板表面镀镍

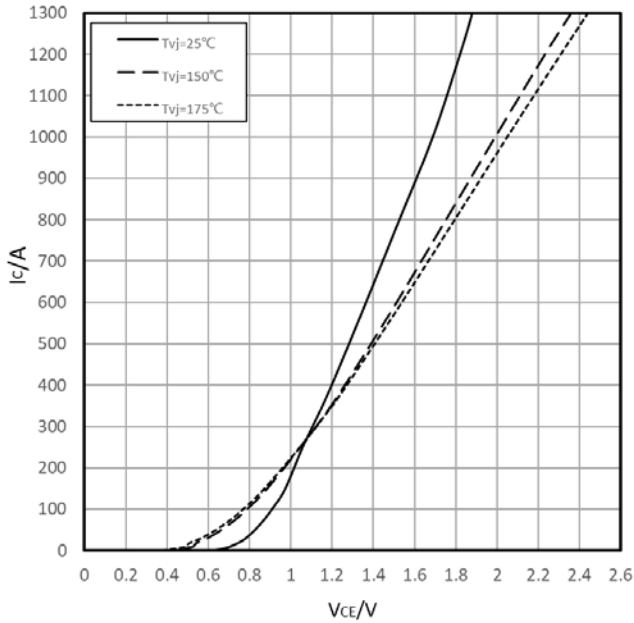
2) CTI 约为 200

Circuit Diagram / 曲线图

Output characteristic , Inverter IGBT (typical)

输出特性, 逆变IGBT (典型)

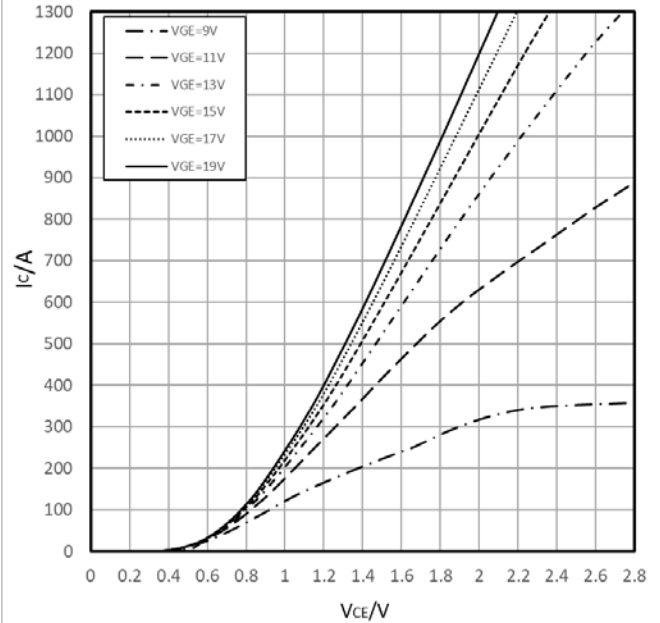
$I_c=f(V_{CE})$, $V_{GE}=15V$ (Inclusive $R_{CC'+EE'}$)



Output characteristic , Inverter IGBT (typical)

输出特性, 逆变IGBT (典型)

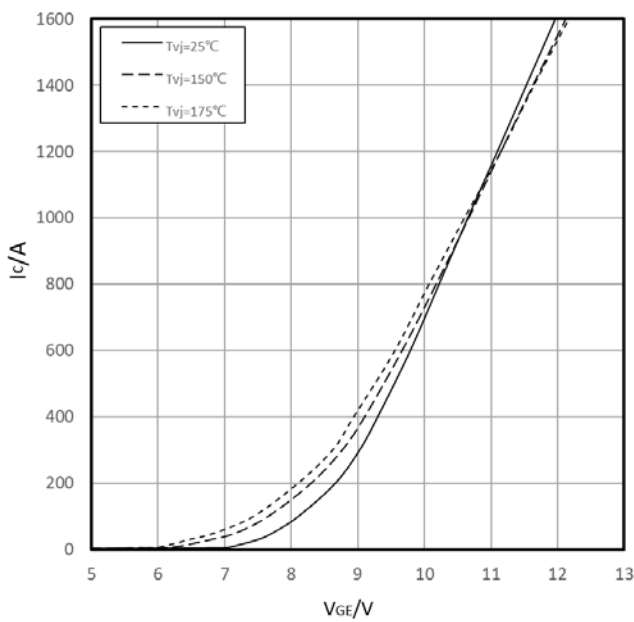
$I_c=f(V_{CE})$, $T_{vj}=150^\circ C$



Transfer characteristic , Inverter IGBT (typical)

传输特性, 逆变IGBT (典型)

$I_c=f(V_{GE})$, $V_{CE}=20V$

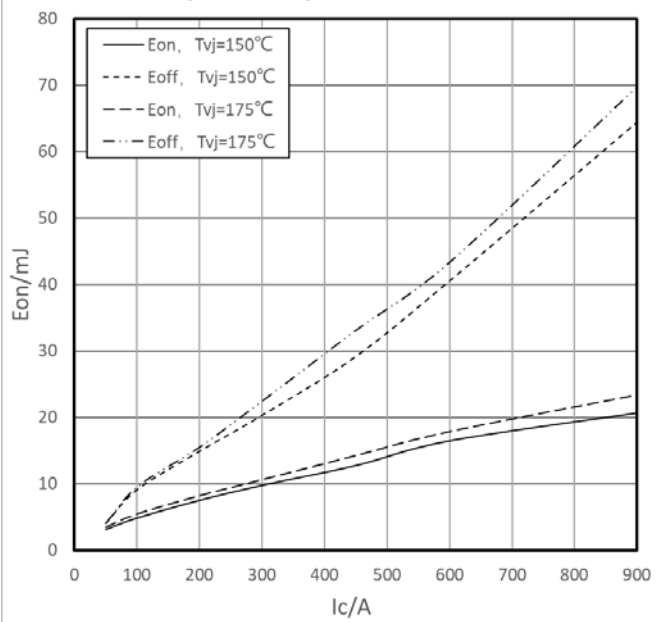


Switching losses , Inverter IGBT (typical)

开关损耗, 逆变IGBT (典型)

$E_{on}=f(I_c)$, $E_{off}=f(I_c)$

$V_{GE}=+15V/-8V$, $R_{gon}=1.0\Omega$, $R_{goff}=5.0\Omega$, $V_{CE}=400V$

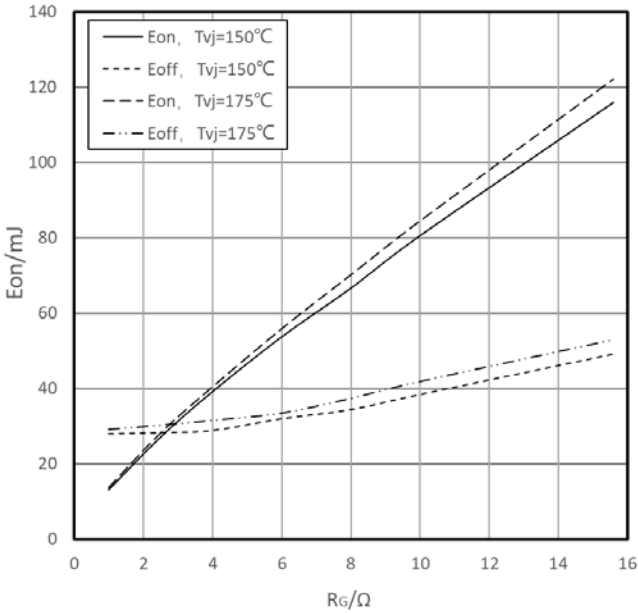


Switching losses , Inverter IGBT (typical)

开关损耗, 逆变IGBT (典型)

$E_{on}=f(R_g), E_{off}=f(R_g)$

$V_{GE}=+15V/-8V, I_c=450A, V_{CE}=400V$

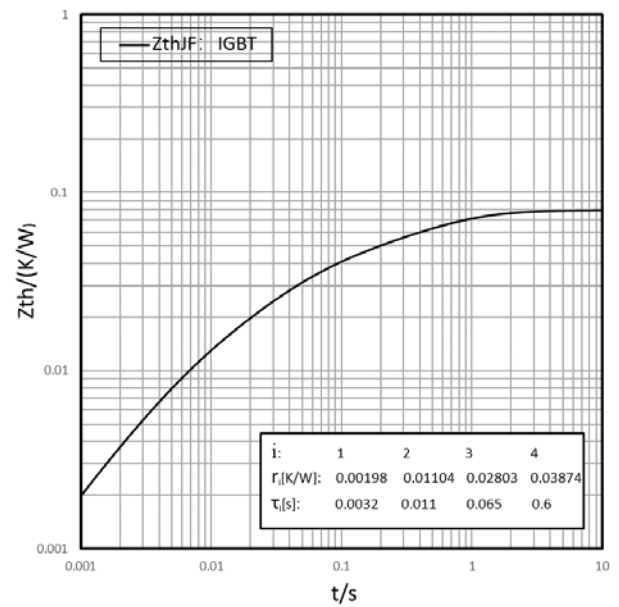


Transient thermal impedance IGBT, Inverter

瞬态热阻, 逆变IGBT

$Z_{thJF}=f(t)$

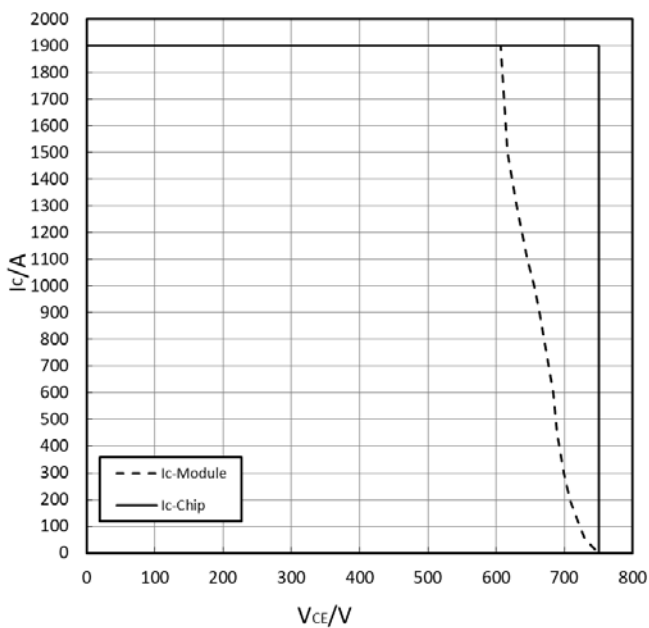
$\Delta V/\Delta t=10dm^3/min; T_f=65^\circ C; 50\% \text{ water}/50\% \text{ ethylenglycol}$



Reverse bias safe operating area , Inverter IGBT (RBSOA)

反偏安全工作区, 逆变IGBT (RBSOA)

$I_c=f(V_{CE}), V_{GE}=+15V/-8V, R_{goff}=5.0\Omega, T_{vj}=175^\circ C$

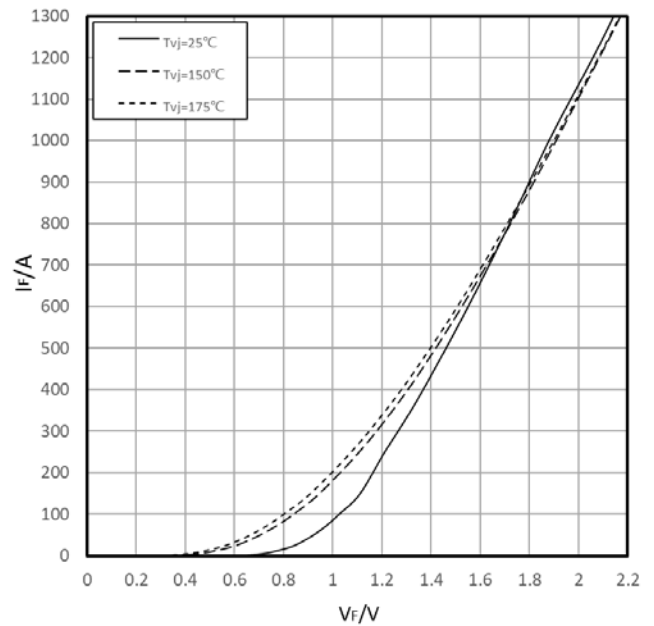


Forward characteristic , Inverter FRD (typical)

正向偏压特性, 逆变FRD (典型)

$I_f=f(V_f)$

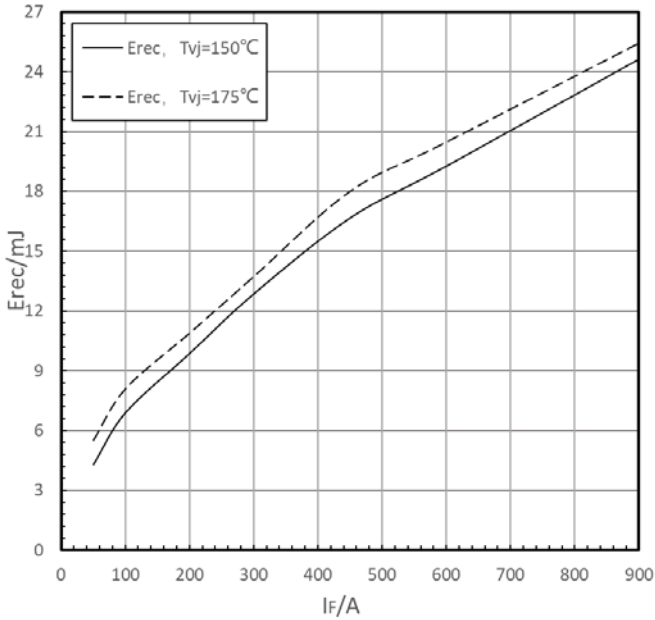
(Inclusive $R_{CC'+EE'}$)



Switching losses , Inverter IGBT (typical)

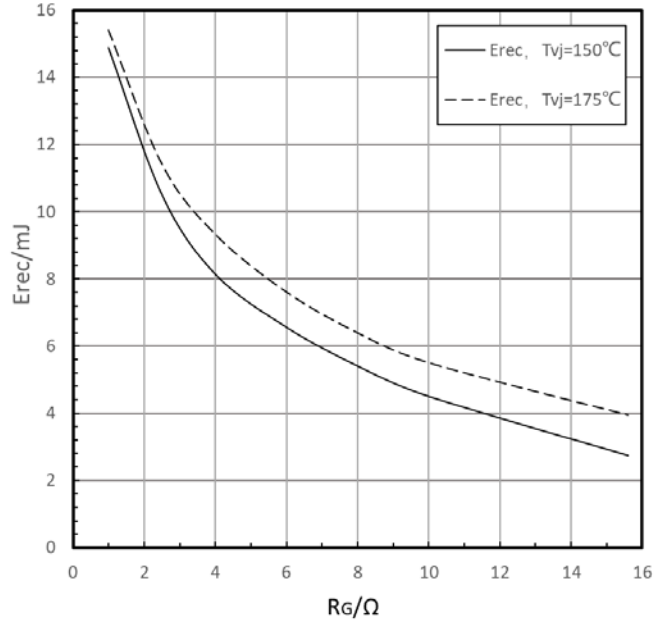
开关损耗, 逆变FRD (典型)

$$E_{rec}=f(I_F), R_{gon}=1.0\Omega, V_{CE}=400V$$


Switching losses , Inverter FRD (typical)

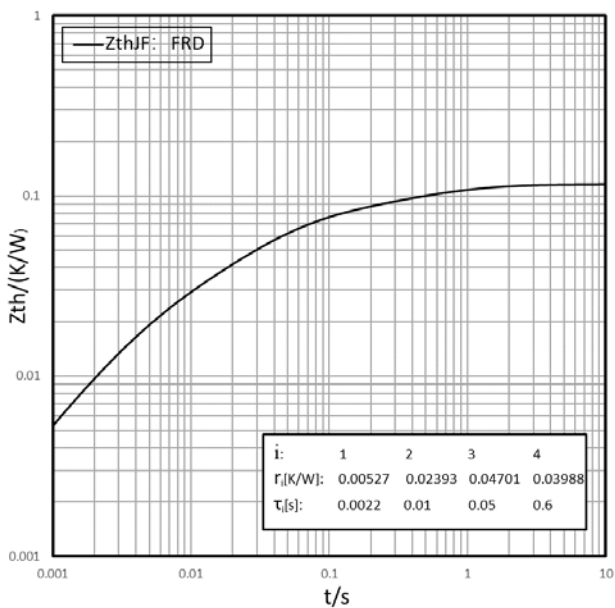
开关损耗, 逆变FRD (典型)

$$E_{rec}=f(R_G), I_F=450A, V_{CE}=400V$$


Transient thermal impedance FRD, Inverter

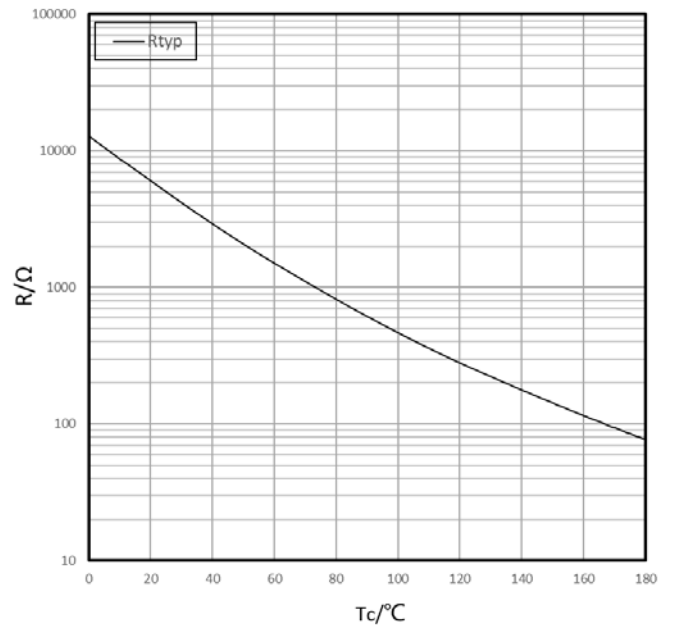
瞬态热阻, 逆变FRD

$$Z_{thJF}=f(t)$$

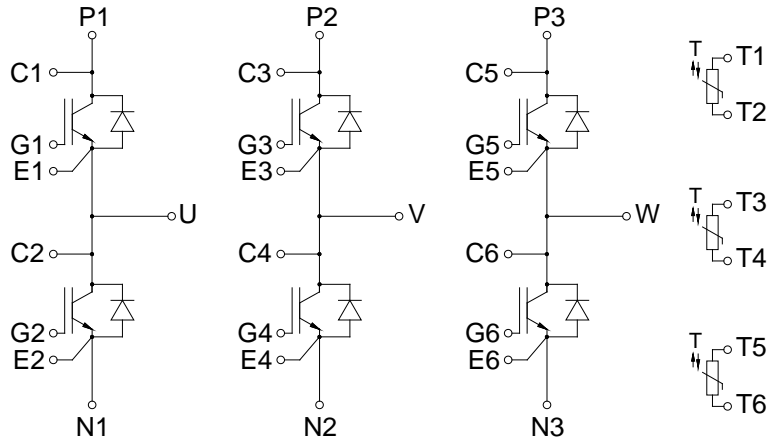
 $\Delta V/\Delta t=10dm^3/min; T_f=65^\circ C; 50\% \text{ water}/50\% \text{ ethylenglycol}$

NTC-Thermistor-temperature characteristic

负温度系数热敏电阻 温度特性

$$R=f(T)$$



Internal Circuit / 内部电路



Package Dimension / 封装尺寸

Dimensions in Millimeters / 毫米为单位

